SABIC LEXAN™ PC PC0703物性表

属性	典型值	UNITS	测试手段
MECHANICAL			
Tensile Stress, yld, Type I, 50 mm/min	63	MPa	ASTM D638
Tensile Strain, yld, Type I, 50 mm/min	6	%	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	>70	%	ASTM D638
Tensile Modulus, 50 mm/min	2350	MPa	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	90	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	2300	MPa	ASTM D790
Hardness, Rockwell R	120	-	ASTM D785
Tensile Stress, yield, 50 mm/min	63	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	6	%	ISO 527
Tensile Strain, break, 50 mm/min	>70	%	ISO 527
Tensile Modulus, 1 mm/min	2350	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	90	MPa	ISO 178
Flexural Modulus, 2 mm/min	2300	MPa	ISO 178
Hardness, Rockwell R	120	-	ISO 2039-2
IMPACT			
Izod Impact, unnotched, 23°C	NB	J/m	ASTM D4812
Izod Impact, notched, 23°C	900	J/m	ASTM D256
Instrumented Dart Impact Energy @ peak, 23°C	65	J	ASTM D3763
Izod Impact, unnotched 80*10*3 +23°C	NB	kJ/m²	ISO 180/1U
Izod Impact, unnotched 80*10*3 -30°C	NB	kJ/m²	ISO 180/1U
Izod Impact, notched 80*10*3 +23°C	70	kJ/m²	ISO 180/1A
Izod Impact, notched 80*10*3 -30°C	12	kJ/m²	ISO 180/1A
THERMAL			
Vicat Softening Temp, Rate B/50	144	°C	ASTM D1525

HDT, 0.45 MPa, 3.2 mm	138	°C	ASTM D648
HDT, 1.82 MPa, 3.2 mm	127	°C	ASTM D648
CTE, -40°C to 95°C, flow	7.E-05	1/°C	ASTM E831
Thermal Conductivity	0.2	W/m-°C	ASTM C177
Thermal Conductivity	0.2	W/m-°C	ISO 8302
CTE, 23°C to 80°C, flow	7.E-05	1/°C	ISO 11359-2
Ball Pressure Test, 125°C +/- 2°C	Passes	-	IEC 60695-10-2
Vicat Softening Temp, Rate B/50	144	°C	ISO 306
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	138	°C	ISO 75/Bf
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	127	°C	ISO 75/Af
PHYSICAL			
Specific Gravity	1.2	-	ASTM D792
Water Absorption, (23°C/Saturated)	0.35	%	ASTM D570
Mold Shrinkage on Tensile Bar, flow	0.5-0.7	%	SABIC method
Mold Shrinkage, flow, 3.2 mm	0.5-0.7	%	SABIC method
Melt Flow Rate, 300°C/1.2 kgf	7	g/10 min	ASTM D1238
Density	1.2	g/cm³	ISO 1183
Water Absorption, (23°C/saturated)	0.35	%	ISO 62-1
Melt Volume Rate, MVR at 300°C/1.2 kg	6	cm³/10 min	ISO 1133
OPTICAL			
Light Transmission, 2.54 mm	88-90	%	ASTM D1003
Haze, 2.54 mm	<0.8	%	ASTM D1003
Refractive Index	1.586	-	ASTM D542
Refractive Index	1.586	-	ISO 489
ELECTRICAL			
Volume Resistivity	>1.E+15	Ω.cm	ASTM D257
Dielectric Strength, 1.6 mm	27	kV/mm	ASTM D149
Relative Permittivity, 60 Hz	3	-	ASTM D150
Relative Permittivity, 1 MHz	3	-	ASTM D150
Dissipation Factor, 60 Hz	0.001	-	ASTM D150
Dissipation Factor, 1 MHz	0.01	-	ASTM D150

Volume Resistivity	>1.E+15	Ω.cm	IEC 60093
Dielectric Strength, 1.6 mm	27	kV/mm	IEC 60243-1
Relative Permittivity, 60 Hz	3	-	IEC 60250
Relative Permittivity, 1 MHz	3	-	IEC 60250
Dissipation Factor, 60 Hz	0.001	-	IEC 60250
Dissipation Factor, 1 MHz	0.01	-	IEC 60250
Injection Molding			
Drying Temperature	120	°C	
Drying Time	2-4	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	290-320	°C	
Nozzle Temperature	280-310	°C	
Front - Zone 3 Temperature	290-320	°C	
Middle - Zone 2 Temperature	280-310	°C	
Rear - Zone 1 Temperature	270-300	°C	
Hopper Temperature	60-80	°C	
Mold Temperature	80-120	°C	